

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	6790	219/600-648.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:42
S2	12	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:21
S3	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:22
S4	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:22
S5	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:22
S6	6808	S1 or S2 or S3 or S4 or S5	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:22
S7	8	S6 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:24
S8	8	S6 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:24
S9	0	S8 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:24
S10	94	S6 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:25
S11	84	S6 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:42
S12	11991	219/600-704.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:42
S13	12007	S6 or S12	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:59
S14	5	S13 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:53

S15	7	S13 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 13:00
S16	3	S13 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:59
S17	0	S14 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 12:59
S19	478094	S13 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 13:00
S20	12	S13 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/08 13:00
S21	6793	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:35
S22	12	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:35
S23	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:35
S24	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:35
S25	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:35
S26	6811	S21 or S22 or S23 or S24 or S25	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:35
S27	12001	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:35
S28	12017	S26 or S27	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:35
S29	7	S28 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:35
S30	7	S29 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:35
S31	6793	219/600-648.ccls	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36

S32	12	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S33	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S34	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S35	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S36	6811	S21 or S22 or S23 or S24 or S25	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S37	8	S26 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S38	8	S26 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S39	0	S38 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S40	94	S26 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S41	84	S26 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S42	12001	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S43	12017	S26 or S27	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S44	5	S28 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S45	7	S28 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S46	3	S28 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36

S47	0	S44 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S48	481453	S28 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S49	12	S28 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/08/19 06:36
S50	6829	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S51	17	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S52	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S53	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S54	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S55	6852	S50 or S51 or S52 or S53 or S54	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S56	8	S55 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S57	8	S55 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S58	0	S57 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S59	95	S55 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S60	85	S55 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S61	12083	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40

S62	12104	S55 or S61	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S63	5	S62 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S64	7	S62 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S65	3	S62 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S66	0	S63 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S67	551318	S62 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S68	12	S62 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S69	6829	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S70	17	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S71	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S72	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S73	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S74	6852	S69 or S70 or S71 or S72 or S73	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S75	12083	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S76	12104	S74 or S75	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S77	7	S76 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40

S78	7	S77 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S79	6829	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S80	17	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S81	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S82	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S83	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S84	6852	S69 or S70 or S71 or S72 or S73	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S85	8	S74 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S86	8	S74 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S87	0	S86 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S88	95	S74 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S89	85	S74 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S90	12083	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S91	12104	S74 or S75	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S92	7	S76 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40

S93	3	S76 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:51
S94	5	S76 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S95	0	S94 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S96	551318	S76 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S97	8	S74 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S98	5	S76 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S99	12	S76 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:40
S100	6829	219/600-648.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S101	17	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S102	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S103	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S104	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S105	6852	S50 or S51 or S52 or S53 or S54	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S106	8	S55 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S107	8	S55 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50

S108	0	S57 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S109	95	S55 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S110	85	S55 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S111	12083	219/600-704.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S112	12104	S55 or S61	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S113	5	S62 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S114	7	S62 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S115	3	S62 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S116	0	S63 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S117	551318	S62 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S118	12	S62 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:57
S119	6829	219/600-648.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S120	17	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S121	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S122	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S123	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50

S124	6852	S69 or S70 or S71 or S72 or S73	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S125	12083	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S126	12104	S74 or S75	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S127	7	S76 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S128	7	S77 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S129	6829	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S130	17	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S131	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S132	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S133	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S134	6852	S69 or S70 or S71 or S72 or S73	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S135	8	S74 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S136	0	S86 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S137	95	S74 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S138	85	S74 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S139	12083	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50

S140	12104	S74 or S75	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S141	7	S76 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S142	3	S76 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S143	0	S94 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S144	551318	S76 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S145	8	S74 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S146	5	S76 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S147	12	S76 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:50
S148	3	S62 and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:58
S149	2	millimeter and frequency and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 12:59
S150	2	wafer with "power amplifier" with array with wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:00
S151	2	wafer with "power amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:01
S152	54	wafer with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:03
S153	0	S152 and millimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:01
S154	0	S152 and 219/748. ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:03

S155	0	S152 and "219"/\$. ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:02
S156	2875	semiconductor with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:03
S157	0	S156 and 219/748. ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:03
S158	981	semiconductor with " amplifier" with array with plurality	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:04
S159	0	S158 and milimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:04
S160	173	S158 and frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:05
S161	300	219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:06
S162	0	S161 and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:06
S163	68	"219"/\$.ccls. and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:14
S164	7	"219"/\$.ccls. and active with array with semiconductor	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:06
S165	0	"219"/\$.ccls. and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:15
S166	0	semiconductro and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:15
S167	193	semiconductor and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:18
S168	1	S167 and donn.in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2006/02/16 13:18
S169	6983	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S170	21	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09

S171	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S172	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S173	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S174	7010	S169 or S170 or S171 or S172 or S173	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S175	9	S174 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S176	9	S174 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S177	0	S176 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S178	105	S174 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S179	95	S174 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S180	12373	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S181	12398	S174 or S180	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S182	8	S181 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S183	9	S181 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S184	3	S181 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S185	0	S182 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09

S186	744358	S181 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S187	15	S181 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S188	6983	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S189	21	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S190	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S191	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S192	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S193	7010	S188 or S189 or S190 or S191 or S192	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S194	12373	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S195	12398	S193 or S194	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S196	9	S195 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S197	9	S196 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S198	6983	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S199	21	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S200	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S201	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09

S202	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S203	7010	S188 or S189 or S190 or S191 or S192	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S204	9	S193 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S205	9	S193 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S206	0	S205 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S207	105	S193 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S208	95	S193 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S209	12373	219/600-704.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S210	12398	S193 or S194	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S211	9	S195 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S212	3	S195 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S213	8	S195 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S214	0	S213 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S215	744358	S195 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S216	9	S193 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09

S217	8	S195 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S218	15	S195 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S219	6983	219/600-648 ccls	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S220	21	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S221	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S222	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S223	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S224	7010	S219 or S220 or S221 or S222 or S223	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S225	9	S224 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S226	9	S224 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S227	0	S226 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S228	105	S224 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S229	95	S224 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S230	12373	219/600-704 ccls	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S231	12398	S224 or S230	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09

S232	9	S231 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S233	3	S231 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S234	8	S231 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S235	0	S234 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S236	744358	S231 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S237	6983	219/600-648.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S238	21	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S239	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S240	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S241	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S242	7010	S237 or S238 or S239 or S240 or S241	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S243	12373	219/600-704.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S244	12398	S242 or S243	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S245	9	S244 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S246	6983	219/600-648.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S247	21	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09

S248	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S249	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S250	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S251	7010	S237 or S238 or S239 or S240 or S241	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S252	9	S242 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S253	9	S242 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S254	0	S253 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S255	105	S242 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S256	95	S242 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S257	12373	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S258	12398	S242 or S243	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S259	9	S244 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S260	8	S244 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S261	0	S260 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S262	744358	S244 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09

S263	9	S224 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S264	8	S231 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S265	15	S231 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S266	9	S245 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S267	9	S242 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S268	8	S244 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S269	15	S244 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S270	6983	219/600-648.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S271	21	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S272	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S273	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S274	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S275	7010	S219 or S220 or S221 or S222 or S223	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S276	9	S224 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S277	0	S226 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09

S278	105	S224 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S279	95	S224 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S280	12373	219/600-704.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S281	12398	S224 or S230	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S282	9	S231 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S283	3	S231 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S284	0	S234 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S285	744358	S231 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S286	6983	219/600-648.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S287	21	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S288	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S289	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S290	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S291	7010	S237 or S238 or S239 or S240 or S241	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S292	12373	219/600-704.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S293	12398	S242 or S243	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09

S294	9	S244 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S295	6983	219/600-648.ccls	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S296	21	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S297	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S298	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S299	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S300	7010	S237 or S238 or S239 or S240 or S241	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S301	9	S242 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S302	0	S253 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S303	105	S242 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S304	95	S242 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S305	12373	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S306	12398	S242 or S243	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S307	9	S244 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S308	3	S244 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S309	0	S260 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09

S310	744358	S244 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S311	9	S224 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S312	8	S231 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S313	3	S244 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S314	15	S231 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S315	9	S245 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S316	9	S242 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S317	8	S244 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S318	15	S244 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S319	6	S231 and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S320	6	millimeter and frequency and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S321	3	wafer with "power amplifier" with array with wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S322	3	wafer with "power amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S323	67	wafer with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S324	1	S323 and millimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09

S325	67	wafer with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S326	0	S323 and 219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S327	0	S323 and "219"/\$.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S328	3270	semiconductor with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S329	0	S328 and 219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S330	1089	semiconductor with " amplifier" with array with plurality	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S331	0	S330 and millimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S332	194	S330 and frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S333	306	219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S334	0	S333 and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S335	72	"219"/\$.ccls. and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S336	7	"219"/\$.ccls. and active with array with semiconductor	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S337	0	"219"/\$.ccls. and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S338	0	semiconducto and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S339	230	semiconductor and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09
S340	1	S339 and donn.in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:09

S341	9181	219/678-748.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:16
S342	9184	S341 or S171 or S172	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2007/07/19 10:16
S343	7074	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S344	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S345	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S346	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S347	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S348	7103	S343 or S344 or S345 or S346 or S347	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S349	9	S348 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S350	9	S348 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S351	0	S350 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S352	111	S348 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S353	101	S348 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S354	12534	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S355	12561	S348 or S354	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S356	8	S355 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S357	10	S355 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S358	3	S355 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S359	0	S356 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S360	914384	S355 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S361	16	S355 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S362	7074	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S363	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S364	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S365	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S366	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S367	7103	S362 or S363 or S364 or S365 or S366	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S368	12534	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S369	12561	S367 or S368	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S370	10	S369 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S371	10	S370 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S372	7074	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S373	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S374	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S375	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S376	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S377	7103	S362 or S363 or S364 or S365 or S366	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S378	9	S367 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S379	9	S367 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S380	0	S379 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S381	111	S367 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S382	101	S367 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S383	12534	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S384	12561	S367 or S368	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S385	8	S369 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S386	10	S369 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S387	3	S369 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S388	0	S385 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S389	914384	S369 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S390	16	S369 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S391	7074	219/600-648.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S392	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S393	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S394	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S395	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S396	7103	S391 or S392 or S393 or S394 or S395	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S397	9	S396 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S398	9	S396 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S399	0	S398 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S400	111	S396 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S401	101	S396 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S402	12534	219/600-704.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S403	12561	S396 or S402	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S404	8	S403 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S405	10	S403 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S406	3	S403 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S407	0	S404 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S408	914384	S403 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S409	16	S403 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S410	7074	219/600-648.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S411	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S412	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S413	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S414	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S415	7103	S410 or S411 or S412 or S413 or S414	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S416	12534	219/600-704.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S417	12561	S415 or S416	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S418	10	S417 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S419	10	S418 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S420	7074	219/600-648 ccls	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S421	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S422	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S423	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S424	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S425	7103	S410 or S411 or S412 or S413 or S414	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S426	9	S415 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S427	9	S415 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S428	0	S427 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S429	111	S415 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S430	101	S415 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S431	12534	219/600-704 ccls	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S432	12561	S415 or S416	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S433	10	S417 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S434	3	S417 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S435	8	S417 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S436	0	S435 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S437	914384	S417 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S438	9	S415 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S439	8	S417 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S440	16	S417 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S441	7074	219/600-648.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S442	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S443	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S444	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S445	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S446	7103	S391 or S392 or S393 or S394 or S395	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S447	9	S396 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S448	9	S396 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S449	0	S398 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S450	111	S396 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S451	101	S396 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S452	12534	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S453	12561	S396 or S402	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S454	8	S403 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S455	10	S403 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S456	3	S403 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S457	0	S404 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S458	914384	S403 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S459	16	S403 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S460	7074	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S461	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S462	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S463	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S464	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S465	7103	S410 or S411 or S412 or S413 or S414	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S466	12534	219/600-704.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S467	12561	S415 or S416	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S468	10	S417 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S469	10	S418 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S470	7074	219/600-648.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S471	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S472	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S473	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S474	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S475	7103	S410 or S411 or S412 or S413 or S414	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S476	9	S415 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S477	0	S427 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S478	111	S415 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S479	101	S415 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S480	12534	219/600-704.cds	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S481	12561	S415 or S416	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S482	10	S417 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S483	3	S417 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S484	0	S435 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S485	914384	S417 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S486	9	S415 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S487	8	S417 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S488	16	S417 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S489	7	S403 and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S490	10	millimeter and frequency and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S491	4	wafer with "power amplifier" with array with wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S492	4	wafer with "power amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S493	76	wafer with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S494	3	S493 and millimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S495	0	S493 and 219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S496	0	S493 and "219"/\$.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S497	3467	semiconductor with "amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S498	0	S497 and 219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S499	1115	semiconductor with "amplifier" with array with plurality	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S500	0	S499 and milimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S501	205	S499 and frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S502	307	219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S503	0	S502 and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S504	73	"219"/\$.ccls. and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S505	7	"219"/\$.ccls. and active with array with semiconductor	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S506	1	"219"/\$.ccls. and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S507	0	semiconductro and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S508	246	semiconductor and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S509	1	S508 and donn.in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S510	7074	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S511	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S512	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S513	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S514	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S515	7103	S510 or S511 or S512 or S513 or S514	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S516	9	S515 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S517	9	S515 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S518	0	S517 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S519	111	S515 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S520	101	S515 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S521	12534	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S522	12561	S515 or S521	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S523	8	S522 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S524	10	S522 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S525	3	S522 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S526	0	S523 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S527	914384	S522 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S528	16	S522 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S529	7074	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S530	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S531	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S532	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S533	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S534	7103	S529 or S530 or S531 or S532 or S533	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S535	12534	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S536	12561	S534 or S535	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S537	10	S536 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S538	10	S537 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S539	7074	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S540	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S541	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S542	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S543	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S544	7103	S529 or S530 or S531 or S532 or S533	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S545	9	S534 and (levitate or float) with heat and (mm or milimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S546	9	S534 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S547	0	S546 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S548	111	S534 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S549	101	S534 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S550	12534	219/600-704.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S551	12561	S534 or S535	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S552	10	S536 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S553	3	S536 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S554	8	S536 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S555	0	S554 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S556	914384	S536 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S557	9	S534 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S558	8	S536 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S559	16	S536 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S560	7074	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S561	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S562	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S563	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S564	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S565	7103	S560 or S561 or S562 or S563 or S564	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S566	9	S565 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S567	9	S565 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S568	0	S567 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S569	111	S565 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S570	101	S565 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S571	12534	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S572	12561	S565 or S571	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S573	10	S572 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S574	3	S572 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S575	8	S572 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S576	0	S575 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S577	914384	S572 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S578	7074	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S579	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S580	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S581	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S582	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S583	7103	S578 or S579 or S580 or S581 or S582	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S584	12534	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S585	12561	S583 or S584	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S586	10	S585 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S587	7074	219/600-648.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S588	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S589	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S590	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S591	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S592	7103	S578 or S579 or S580 or S581 or S582	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S593	9	S583 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S594	9	S583 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S595	0	S594 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S596	111	S583 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S597	101	S583 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S598	12534	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S599	12561	S583 or S584	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S600	10	S585 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S601	8	S585 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S602	0	S601 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S603	914384	S585 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S604	9	S565 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S605	8	S572 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S606	16	S572 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S607	10	S586 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S608	9	S583 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S609	8	S585 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S610	16	S585 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S611	7074	219/600-648.cds.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S612	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S613	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S614	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S615	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S616	7103	S560 or S561 or S562 or S563 or S564	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S617	9	S565 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S618	0	S567 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S619	111	S565 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S620	101	S565 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S621	12534	219/600-704.ccls	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S622	12561	S565 or S571	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S623	10	S572 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S624	3	S572 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S625	0	S575 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S626	914384	S572 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S627	7074	219/600-648.ccls	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S628	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S629	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S630	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S631	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S632	7103	S578 or S579 or S580 or S581 or S582	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S633	12534	219/600-704.ccls	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S634	12561	S583 or S584	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S635	10	S585 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S636	7074	219/600-648 ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S637	23	(gallivan and brown). in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S638	2	"4756765".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S639	2	"5268548".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S640	2	"6169277".pn.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S641	7103	S578 or S579 or S580 or S581 or S582	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S642	9	S583 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S643	0	S594 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S644	111	S583 and wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S645	101	S583 and wafer and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S646	12534	219/600-704.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S647	12561	S583 or S584	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S648	10	S585 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S649	3	S585 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S650	0	S601 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S651	914384	S585 na dwafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S652	9	S565 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S653	8	S572 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S654	3	S585 and microwave and collimated and cook	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S655	16	S572 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S656	10	S586 and microwave and collimated	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S657	9	S583 and (levitate or float) with heat and (mm or millimeter or radiation)	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S658	8	S585 and cool and (surface with sensor) and array and heat	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S659	16	S585 and wafer with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S660	7	S572 and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S661	10	millimeter and frequency and wafer with array with amplifier	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S662	4	wafer with "power amplifier" with array with wafer	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S663	4	wafer with "power amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S664	76	wafer with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S665	3	S664 and millimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S666	76	wafer with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S667	0	S664 and 219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S668	0	S664 and "219"/\$.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S669	3467	semiconductor with " amplifier" with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S670	0	S669 and 219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S671	1115	semiconductor with " amplifier" with array with plurality	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S672	0	S671 and millimeter with frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S673	205	S671 and frequency	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S674	307	219/748.ccls.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S675	0	S674 and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S676	73	"219"/\$.ccls. and active with array	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S677	7	"219"/\$.ccls. and active with array with semiconductor	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S678	1	"219"/\$.ccls. and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S679	0	semiconductro and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S680	246	semiconductor and active with array with antenna	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19

S681	1	S680 and donn.in.	USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S682	9428	219/678-748.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S683	9431	S682 or S512 or S513	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:19
S684	6	"6572830".pn. or "5886671".pn. or "6765535".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/07/16 10:22

7/30/2008 6:15:41 AM

C:\Documents and Settings\drobinson3\My Documents\EAST\Workspaces\10693125 219
648.wsp